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InvenSense
MPU-6515
6-Axis Accelerometer Gyroscope
MEMS Motion Sensor

MEMS Overview Analysis
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Table of Contents – All Modules

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- Package Photograph – Bottom
- Package X-Ray(s)
- Tilt-View SEM of Depotted Die (MEMS, ASIC, and Cap)
- High Resolution ASIC Die Photograph with Die Size
- High Resolution MEMS Die Photograph with Die Size

Module 2: MEMS Package Analysis

- Full Package Composite (Optical)
- ASIC Details, Such as Edges and Corners (Optical and SEM)
- MEMS Die Details, such as Lid Thickness, Cavity Height, MEMS Die Thickness, and Bond Pads (Optical and SEM)

MEMS ICWorks Surveyor

- Measureable HR SEM Mosaic of the Entire MEMS Structure
- Measure Any Feature, Create Simulation Models in Your MEMS Technology
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